

Advanced Boot Block Flash Memory (C3)

Manufacturers	Intel Corp
Package/Case	2 tr bga
Product Type	Memory
RoHS	
Lifecycle	



Images are for reference only

Please submit RFQ for RC28F320C3TD70 or [Email to us: sales@ovaga.com](mailto:sales@ovaga.com) We will contact you in 12 hours.

[RFQ](#)

General Description

RC28F320C3TD70 is a flash memory device manufactured by Intel Corporation. It is a 32-megabit (Mb) NOR flash memory chip, which means it can store up to 32 million bits of data.

Features

Organization: 4M x 8 (32Mb)

Supply voltage: 2.7V to 3.6V

Access time: 70 ns

Interface: Parallel

Package type: TSOP

Operating temperature range: -40°C to +85°C

Application

Embedded systems

Consumer electronics

Automotive applications

Industrial equipment

Communication systems



Related Products



[RC28F320J3D-75](#)

Intel Corp
BGA-64



[RC28F256P30T85](#)

Intel Corp
BGA64



[RC28F128K3C115](#)

Intel Corp
BGA64



[RC28F256J3F95A](#)

Intel Corp
64-TBGA



[RC28F640J3D75](#)

Intel Corp
FBGA-64



[RC28F256K3C120](#)

Intel Corp
BGA-64



[RC28F128J3A-150](#)

Intel Corp
BGA-64



[RC28F640J3D-75](#)

Intel Corp
BGA